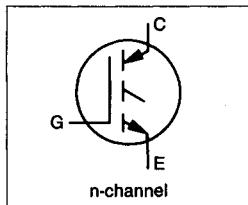


INSULATED GATE BIPOLEAR TRANSISTOR

UltraFast™ IGBT



Description

Insulated Gate Bipolar Transistors (IGBTs) from International Rectifier have higher current densities than comparable bipolar transistors, while at the same time having simpler gate-drive requirements of the familiar power MOSFET. They provide substantial benefits to a host of higher-voltage, higher-current applications.

The performance of various IGBTs varies greatly with frequency. Note that IR now provides the designer with a speed benchmark (f_{IC2} , or the "half-current frequency"), as well as an indication of the current handling capability of the device. Refer to Figure 14.

Product Summary

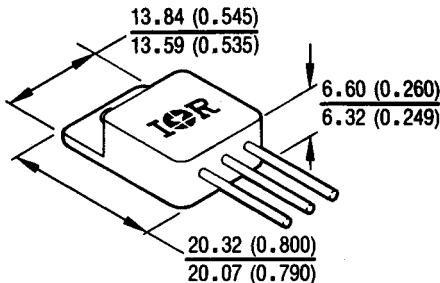
Part Number	V_{CE}	$V_{CE(on)}$	I_C	E_{ts}
IRGMC50U	600V	3.0V	35A*	2.8 mJ

Features:

- Electronically Isolated and Hermetically Sealed
- Simple Drive Requirements
- Latch-proof
- Ultra-fast operation > 10 kHz
- Switching-Loss Rating includes all "tail" losses
- Ceramic eyelets

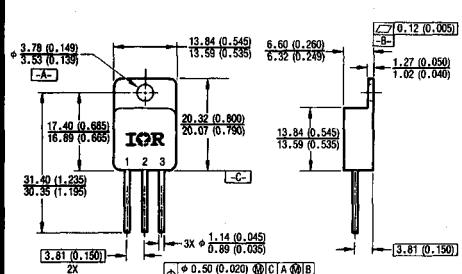
G

CASE STYLE AND DIMENSIONS



CAUTION

BERYLIA WARNING PER MIL-S-19500
SEE PAGE G-105



NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M - 1982.

2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).

LEGEND

1 COLLECTOR

2 Emitter

3 GATE

**For leadform configuration see page G-105, fig. 15

Conforms to JEDEC Outline TO-254AA**
Dimensions in Millimeters and (Inches)

Absolute Maximum Ratings

	Parameter	Max.	Units
$I_C @ T_C = 25^\circ\text{C}$	Continuous Collector Current	35*	A
$I_C @ T_C = 100^\circ\text{C}$	Continuous Collector Current	20	
I_{CM}	Pulsed Collector Current ①	160	
V_{CE}	Collector-to-Emitter Breakdown Voltage	600	V
V_{GE}	Gate-to-Emitter Voltage	± 20	
I_{LM}	Clamped Inductive Load Current ②	160	A
$P_D @ T_C = 25^\circ\text{C}$	Maximum Power Dissipation	150	
$P_D @ T_C = 100^\circ\text{C}$	Maximum Power Dissipation	60	W
T_J T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	
	Lead Temperature, for 10 sec.	300 (0.063 in. (1.6mm) from case)	°C
	Weight	9.3 (typical)	

* I_C current limited by pin diameter**Thermal Resistance**

	Parameter	Min.	Typ.	Max.	Units
R_{JC}	Junction-to-Case	—	—	0.83	K/W ⑤
R_{CS}	Case-to-Sink, flat, greased surface	—	0.12	—	
R_{JA}	Junction-to-Ambient, typical socket mount	—	—	48	

Electrical Characteristic @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{GE} = 0\text{V}$, $I_C = 1.0\text{ mA}$
$V_{(BR)ECS}$	Emitter-to-Collector Breakdown Volt. ③	23	—	—		$V_{GE} = 0\text{V}$, $I_C = 1.0\text{ A}$
$\Delta V_{(BR)CES}/\Delta T_J$	Temp. Coeff. of Breakdown Voltage	—	0.60	—	V/ $^\circ\text{C}$	$V_{GE} = 0\text{V}$, $I_C = 1.0\text{ mA}$
$V_{CE(on)}$	Collector-to-Emitter Saturation Voltage	—	—	3.0	V	$V_{GE} = 15\text{V}$, $I_C = 20\text{A}$ See Fig. 4
		—	2.4	—		$V_{GE} = 15\text{V}$, $I_C = 35\text{A}$
		—	1.9	—		$V_{CE} = 15\text{V}$, $I_C = 20\text{A}$, $T_J = 125^\circ\text{C}$
$V_{GE(th)}$	Gate Threshold Voltage	3.0	—	5.5	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}$, $I_C = 250\text{ }\mu\text{A}$
$\Delta V_{GE(th)}/\Delta T_J$	Temp. Coeff. of Threshold Voltage	—	-13	—		$V_{CE} = V_{GE}$, $I_C = 250\text{ }\mu\text{A}$
g_{fe}	Forward Transconductance ④	16	—	—	S	$V_{CE} \geq 15\text{V}$, $I_C = 20\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	50	μA	$V_{GE} = 0\text{V}$, $V_{CE} = 480\text{V}$, $T_J = 25^\circ\text{C}$
		—	—	5000		$V_{GE} = 0\text{V}$, $V_{CE} = 480\text{V}$, $T_J = 125^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 500	nA	$V_{GE} = \pm 20\text{V}$

Notes:

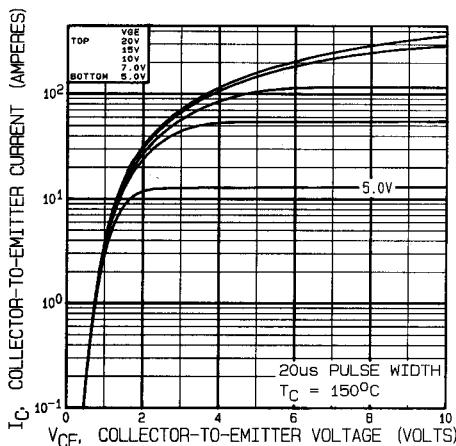
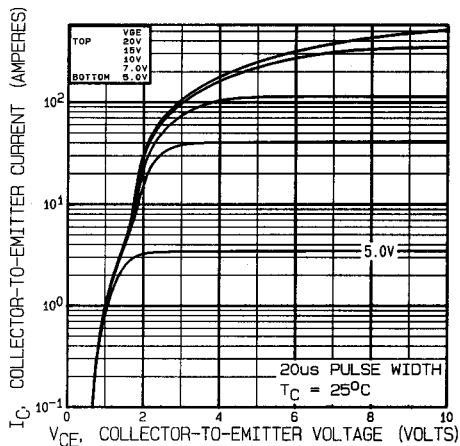
- ① Repetitive rating; $V_{GE} = 20\text{V}$, pulse width limited by max. junction temperature (See figure 12b).
- ② $V_{CC} = 80\%$ (BV_{CES}), $V_{GE} = 20\text{V}$, $L \geq 10\text{ }\mu\text{H}$, $R_G = 10\Omega$, (See figure 12a)

③ Pulse width $\leq 80\text{ }\mu\text{s}$; duty factor $\leq 0.1\%$.④ Pulse width $\leq 5\text{ }\mu\text{s}$, single shot

⑤ K/W equivalent to °C/W

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Q_G	Total Gate Charge (turn-on)	—	115	140	nC	$I_C = 20\text{A}$, $V_{CC} = 300\text{V}$
Q_{GE}	Gate - Emitter Charge (turn-on)	—	15	35		See Figure 6.
Q_{GC}	Gate - Collector Charge (turn-on)	—	35	70		$V_{GE} = 15\text{V}$
$t_{d(on)}$	Turn-On Delay Time	—	—	50	ns	See test circuit, figure 13.
t_r	Rise Time	—	—	75		$I_C = 20\text{A}$, $V_{CC} = 480\text{V}$
$t_{d(off)}$	Turn-Off Delay Time	—	—	300		$T_J = 25^\circ\text{C}$
t_f	Fall Time	—	—	210	mJ	$V_{GE} = 15\text{V}$, $R_G = 2.35\Omega$
E_{on}	Turn-On Switching Loss	—	0.12	—		Energy losses include "tail".
E_{off}	Turn-Off Switching Loss	—	1.6	—		Also see figures 9, 10, & 11.
E_{ts}	Total Switching Loss	—	1.7	2.8	ns	
$t_{d(on)}$	Turn-On Delay Time	—	24	—		$I_C = 20\text{A}$, $V_{CC} = 480\text{V}$
t_r	Rise Time	—	27	—		$T_J = 125^\circ\text{C}$
$t_{d(off)}$	Turn-Off Delay Time	—	180	—		$V_{GE} = 15\text{V}$
t_f	Fall Time	—	130	—	mJ	$R_G = 2.35\Omega$
E_{ts}	Total Switching Loss	—	2.7	—		
L_E	Internal Emitter Inductance	—	8.7	—		Measured 5mm from package.
C_{ies}	Input Capacitance	—	2900	—	pF	$V_{GE} = 0\text{V}$
C_{oes}	Output Capacitance	—	330	—		$V_{CC} = 30\text{V}$
C_{res}	Reverse Transfer Capacitance	—	41	—		$f = 1.0 \text{ MHz}$
C_{cc}	Collector-to-Case Capacitance	—	12	—		See fig 5.



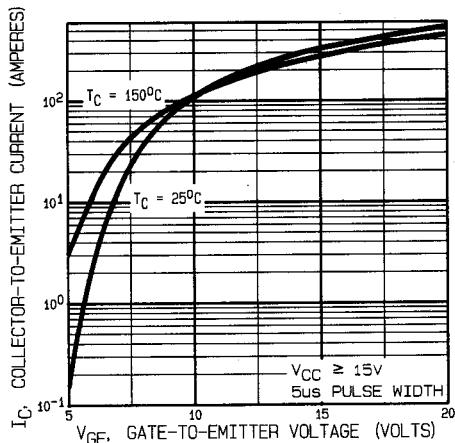


Fig. 3 — Typical Transfer Characteristics

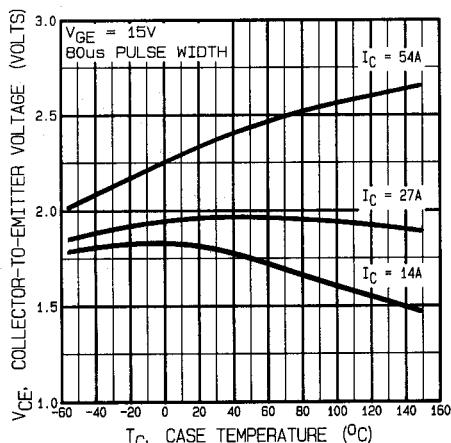


Fig. 4 — Collector-to-Emitter Saturation Voltage vs. Case Temperature

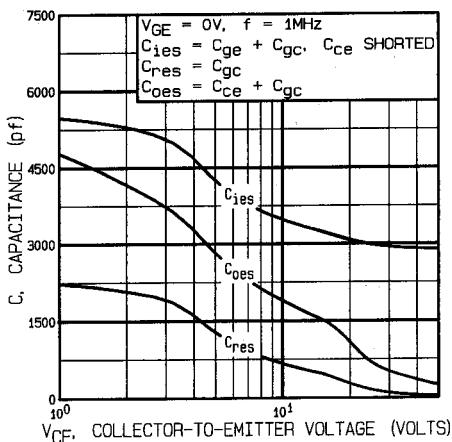


Fig. 5 — Typical Capacitance vs. Collector-to-Emitter Voltage

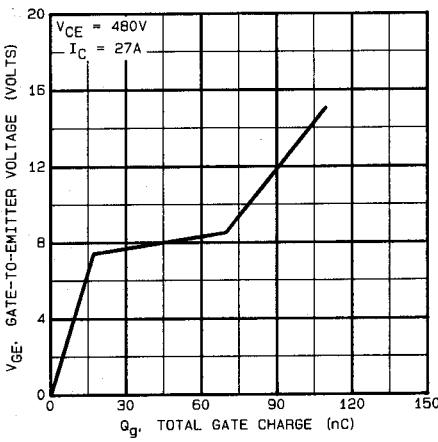


Fig. 6 — Typical Gate Charge vs. Gate-to-Emitter Voltage

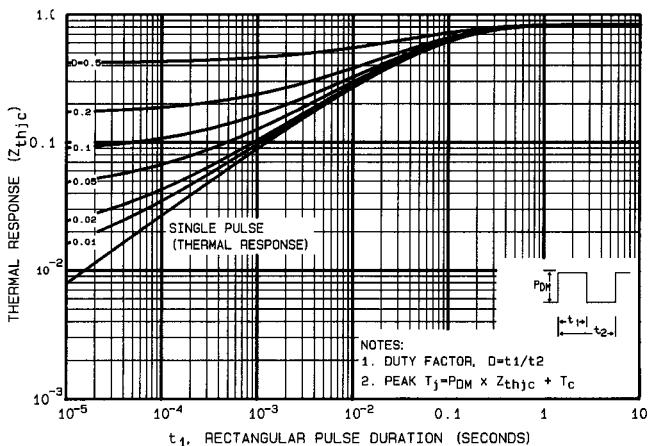


Fig. 7 — Maximum Effective Transient Thermal Impedance, Junction-to-Case

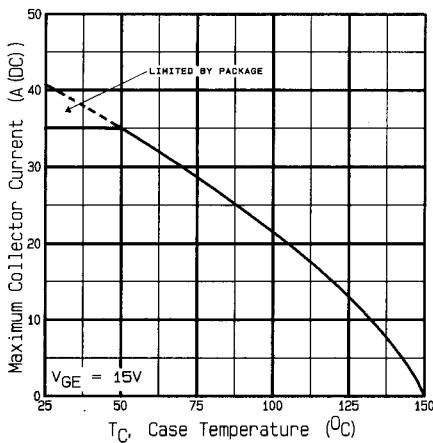


Fig. 8 — Maximum Collector Current vs. Case Temperature

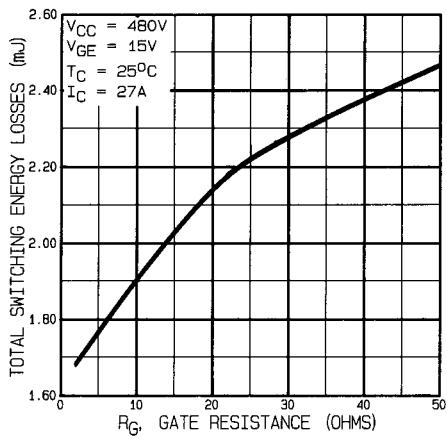


Fig. 9 — Typical Switching Losses vs. Gate Resistance

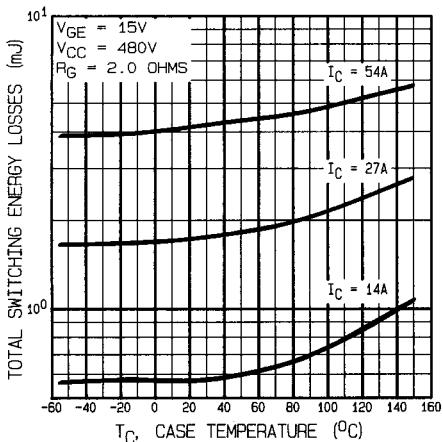


Fig. 10 — Typical Switching Losses vs. Case Temperature

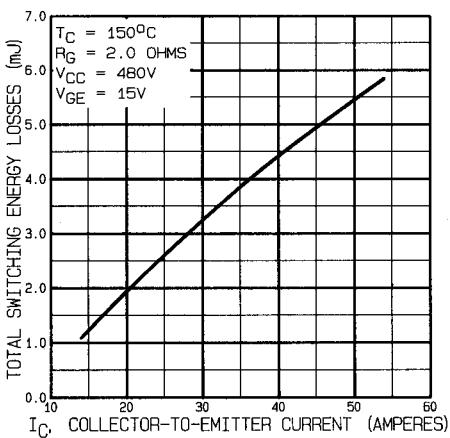


Fig. 11 — Typical Switching Losses vs. Collector-to-Emitter Current

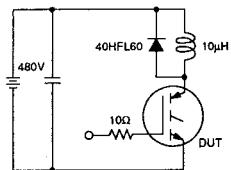


Fig 12a. Clamped Inductive Load Test Circuit

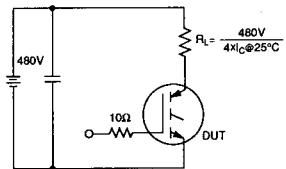


Fig 12b. Pulsed Collector Current Test Circuit

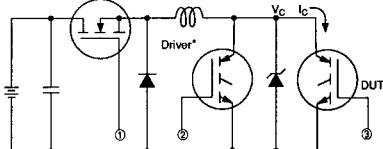
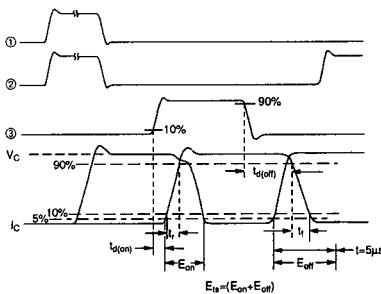


Fig 13a. Switching Loss Test Circuit

* Driver same type as DUT, $V_C = 480\text{V}$



For both, power dissipation = 34W

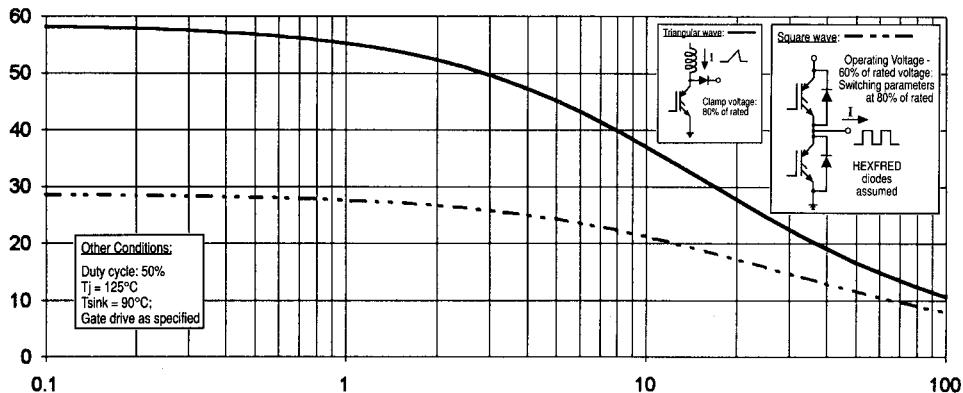


Fig. 14 — Typical Load Current vs. Frequency
(For square wave, $I = I_{RMS}$ of fundamental; for triangular wave, $I = I_{PK}$)

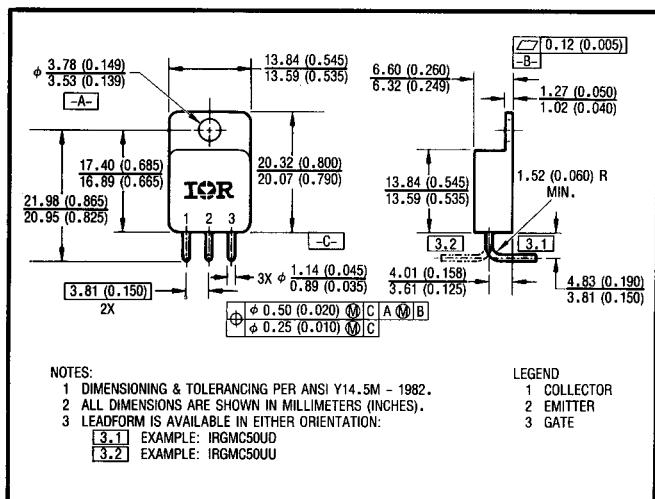


Fig. 15 — Optional Leadforms for Outline TO-254